LM2751 Regulated 2X, 1.5X Switched Capacitor White LED Driver

Check for Samples: LM2751

FEATURES

- Regulated Output Options: 4.5V, 5.0V
- Output Voltage Regulated Within 3%
- Peak Efficiency Over 90%
- 150mA (4.5V) or 80mA (5.0V) Output Current Capability
- Input Voltage Range: 2.8V to 5.5V
- Low Input and Output Voltage Ripple
- <1µA Typical Shutdown Current
- Small Solution Size - NO INDUCTOR
- Programmable 725kHz, 300kHz, 37kHz, or 9.5kHz Switching Frequencies
- 10-pin SON No-Pullback Package: 3mm × 3mm × 0.8mm

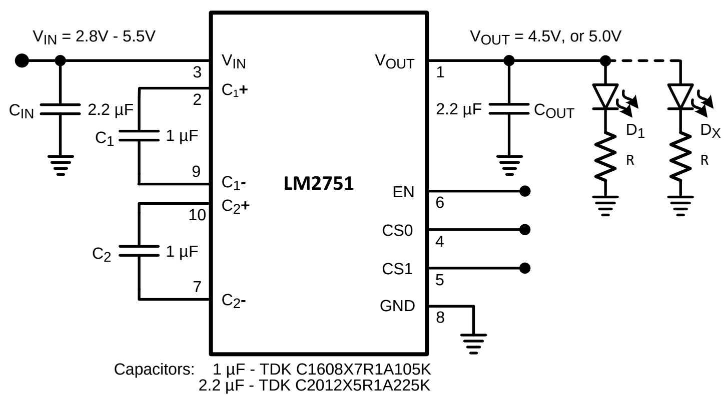
APPLICATIONS

- White LED Display Backlights
- White LED Keypad Backlights
- General Purpose 2×, 1.5× Regulated Charge Pump

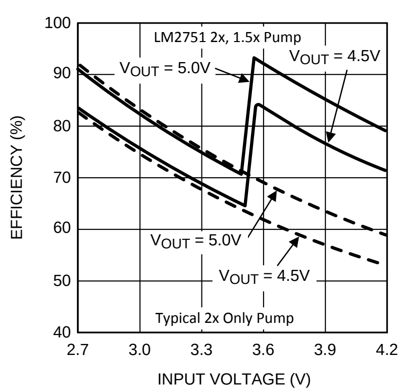
DESCRIPTION

The LM2751 is a constant frequency switched capacitor charge pump with regulated output voltage options of 4.5V, and 5.0V. Over the input voltage range of 2.8V to 5.5V the LM2751 provides up to 150mA of output current and requires only four low-cost ceramic capacitors.

Typical Application Circuit



LM2751 2x/1.5x Efficiency vs. 2x Charge Pump Efficiency



DESCRIPTION (CONTINUED)

The LM2751 provides excellent efficiency without the use of an inductor by operating the charge pump in a gain of 3/2 or 2. The proper gain for maintaining regulation is chosen so that efficiency is maximized over the input voltage range.

LM2751 uses constant frequency pre-regulation to minimize conducted noise on the input and provide a predictable switching frequency. The switching frequency is programmable to 725kHz, 300kHz, 37kHz, or 9.5kHz.

LM2751 is available in a 10-pin SON No-Pullback Package.

Connection Diagram

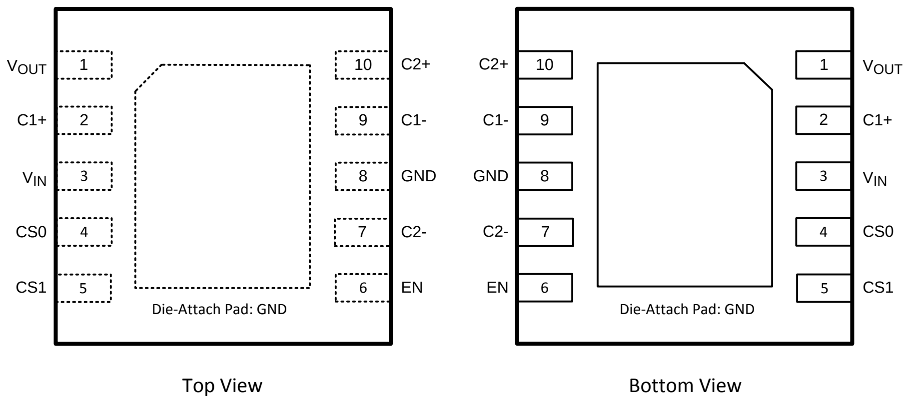


Figure 1. 10-pin SON No Pullback Package (3mm × 3mm × 0.8mm)
See Package Number DSC0010A

PIN DESCRIPTIONS

Pin #	Name	Description
1	V_{OUT}	Pre-Regulated Output.
2	C_{1+}	Flying Capacitor C1 Connection.
3	V_{IN}	Input Supply Range: 2.8V to 5.5V.
4	CS0	Frequency Select Input 0.
5	CS1	Frequency Select Input 1.
6	EN	Enable Pin Logic Input.
7	C_{2-}	Flying Capacitor C2 Connection.
8	GND	Ground.
9	C_{1-}	Flying Capacitor C1 Connection.
10	C_{2+}	Flying Capacitor C2 Connection.

These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

ABSOLUTE MAXIMUM RATINGS[1][2][3]

V_{IN} Pin			−0.3V to 6.0V
EN, CS0, CS1 Pins			−0.3V to (V_{IN}+0.3) w/ 6.0V max
Continuous Power Dissipation[4]			Internally Limited
Junction Temperature ($T_{J-MAX-ABS}$)			150°C
Storage Temperature Range			−65°C to 150°C
Maximum Lead Temperature		(Soldering, 10sec.)	265°C
ESD Rating[5]	Human-body model		2kV
	Machine model		200V

(1) Absolute Maximum Ratings indicate limits beyond which damage to the component may occur. Operating Ratings are conditions under which operation of the device is specified. Operating Ratings do not imply ensured performance limits. For specified performance limits and associated test conditions, see the Electrical Characteristics tables.
(2) All voltages are with respect to the potential at the GND pin.
(3) If Military/Aerospace specified devices are required, please contact the Texas Instruments Sales Office/ Distributors for availability and specifications.
(4) Internal thermal shutdown circuitry protects the device from permanent damage. Thermal shutdown engages at T_J=150°C (typ.) and disengages at T_J=140°C (typ.).
(5) The Human body model is a 100 pF capacitor discharged through a 1.5kΩ resistor into each pin. The machine model is a 200pF capacitor discharged directly into each pin (MIL-STD-883 3015.7).

OPERATING RATINGS[1][2]

Input Voltage Range		2.8V to 5.5V
EN, CS0, CS1 Input Voltage Range		0V to V_{IN}
Junction Temperature (T_J) Range		-40°C to 115°C
Ambient Temperature (T_A) Range[3]		-40°C to 85°C
Recommended Maximum Load Current		
Version B	Freq. = 725kHz	150mA
	Freq. = 300kHz	120mA
	Freq. = 37kHz	40mA
	Freq. = 9.5kHz	10mA
Version A	Freq. = 725kHz	80mA
	Freq. = 300kHz	60mA
	Freq. = 37kHz	16mA
	Freq. = 9.5kHz	4mA

(1) Absolute Maximum Ratings indicate limits beyond which damage to the component may occur. Operating Ratings are conditions under which operation of the device is specified. Operating Ratings do not imply ensured performance limits. For specified performance limits and associated test conditions, see the Electrical Characteristics tables.
(2) All voltages are with respect to the potential at the GND pin.
(3) In applications where high power dissipation and/or poor package thermal resistance is present, the maximum ambient temperature may have to be derated. Maximum ambient temperature (T_{A-MAX}) is dependent on the maximum operation junction temperature ($T_{J-MAX-OP}$ = 115ºC), the maximum power dissipation of the device in the application (P_{D-MAX}), and the junction-to ambient thermal resistance of the part/package in the application (θ_{JA}), as given by the following equation:
$T_{A-MAX} = T_{J-MAX-OP} - (\theta_{JA} \times P_{D-MAX})$.

THERMAL PROPERTIES

Junction-to-Ambient Thermal Resistance, 10-pin SON	Package (θ_{JA})[1]	55°C/W

(1) Junction-to-ambient thermal resistance (θ_{JA}) is taken from a thermal modeling result, performed under the conditions and guidelines set forth in the JEDEC standard JESD51-7. The test board is a 4 layer FR-4 board measuring 102mm x 76mm x 1.6mm with a 2 x 1 array of thermal vias. The ground plane on the board is 50mm x 50mm. Thickness of copper layers are 36µm/18µm /18µm/36µm(1.5oz/1oz/1oz/1.5oz). Ambient temperature in simulation is 22ºC, still air. Power dissipation is 1W. The value of θ_{JA} of the LM2751 in 10-pin SON could fall in a range as wide as 50ºC/W to 150ºC/W (if not wider), depending on PWB material, layout, and environmental conditions. In applications where high maximum power dissipation exists (high V_{IN}, high I_{OUT}), special care must be paid to thermal dissipation issues. For more information on these topics, see the TI AN-1187 Application Report (SNOA401) and the Power Efficiency and Power Dissipation section of this datasheet.

ELECTRICAL CHARACTERISTICS(1)(2)

Limits in standard typeface are for T_A = 25ºC. Limits in **boldface** type apply over the full operating ambient temperature range (-40°C ≤ T_A ≤ +85°C) . Unless otherwise noted, specifications apply to the LM2751 Typical Application Circuit (pg. 1) with: V_{IN} = 3.6V, V(EN) = V_{IN}, CS0 = CS1 = V_{IN}, C_1 = C_2 = 1.0µF, C_{IN} = C_{OUT} = 2.2µF (3).

Symbol	Parameter	Conditions	Min	Typ	Max	Units
V_{OUT}	Output Voltage	Version A, 2.8V ≤ V_{IN} ≤ 5.5V, Freq. = 300kHz, 725kHz, T_A = 25°C I_{OUT} = 0 to 60mA	4.850 (-3%)	5.0	5.150 (+3%)	V
		Version A, 2.8V ≤ V_{IN} ≤ 5.5V, Freq. = 300kHz, I_{OUT} = 0 to 60mA Freq. = 725kHz, I_{OUT} = 0 to 80mA	**4.775 (-4.5%)**		**5.225 (+4.5%)**	
		Version B, 2.8V ≤ V_{IN} ≤ 5.5V, Freq. = 300kHz, 725kHz, T_A = 25°C I_{OUT} = 0 to 120mA	4.343 (-3.5%)	4.5	4.658 (+3.5%)	
		Version B, 2.8V ≤ V_{IN} ≤ 5.5V, Freq. = 300kHz, I_{OUT} = 0 to 120mA Freq. = 725kHz, I_{OUT} = 0 to 150mA	**4.275 (-5%)**		**4.725 (+5%)**	
V_R	Output Ripple	2.8V ≤ V_{IN} ≤ 5.5V I_{OUT} = 60mA		8		mV
I_Q	Quiescent Current	Freq. = 9.5kHz, I_{OUT} = 0mA, V_{IN} = 3.7V		425	**600**	µA
		Freq. = 37kHz, I_{OUT} = 0mA, V_{IN} = 3.7V		450	**640**	
		Freq. = 300kHz, I_{OUT} = 0mA, V_{IN} = 3.7V		700	**900**	
		Freq. = 725kHz, I_{OUT} = 0mA, V_{IN} = 3.7V		1000	**1500**	
I_{SD}	Shutdown Supply Current	V(EN) = 0V		0.77	1.3	µA
		V(EN) = 0V, T_A = 85°C		1.0		
E	Efficiency	I_{OUT} = 80mA (Version A, 5.0V) Freq. = 300kHz, 725kHz		92		%
		I_{OUT} = 150mA (Version B, 4.5V) Freq. = 300kHz, 725kHz		83		
f_{sw}	Switching Frequency	CS0 = High, CS1 = Low 2.8V ≤ V_{IN} ≤ 5.5V	**6.7 (−30%)**	9.5	**12.3 (+30%)**	kHz
		CS0 = Low, CS1 = Low 2.8V ≤ V_{IN} ≤ 5.5V	**26 (−30%)**	37	**48 (+30%)**	
		CS0 = Low, CS1 = High 2.8V ≤ V_{IN} ≤ 5.5V	**210 (−30%)**	300	**390 (+30%)**	
		CS0 = High, CS1 = High 2.8V ≤ V_{IN} ≤ 5.5V	**508 (−30%)**	725	**942 (+30%)**	
V_{IH}	Logic Input High	Input Pins: EN, CS0, CS1 2.8V ≤ V_{IN} ≤ 5.5V	**1.00**		**V_{IN}**	V
V_{IL}	Logic Input Low	Input Pins: EN, CS0, CS1 2.8V ≤ V_{IN} ≤ 5.5V	**0**		**.30**	V
I_{IH}	Logic Input High Current	Input Pins: CS0, CS1 V(CSx) = 1.8V		10		nA
		Input Pin: EN V(EN) = 1.8V(4)		2		µA
I_{IL}	Logic Input Low Current	Input Pins: EN, CS0, CS1 V(EN, CSx) = 0V		10		nA
V_G	Gain Transition Voltage (Version A, B)	1.5X to 2X 2X to 1.5X		3.50 3.58		V
		Hysteresis	**40**	80	**150**	mV
I_{SC}	Short Circuit Output Current	V_{OUT} = 0V		250		mA

(1) All voltages are with respect to the potential at the GND pin.
(2) Min and Max limits are specified by design, test, or statistical analysis. Typical numbers are not ensured, but represent the most likely norm.
(3) C_{IN}, C_{OUT}, C_1, and C_2: Low-ESR Surface-Mount Ceramic Capacitors (MLCCs) used in setting electrical characteristics.
(4) EN Logic Input High Current (I_{IH}) is due to a 1MΩ(typ.) pull-down resistor connected internally between the EN pin and GND.

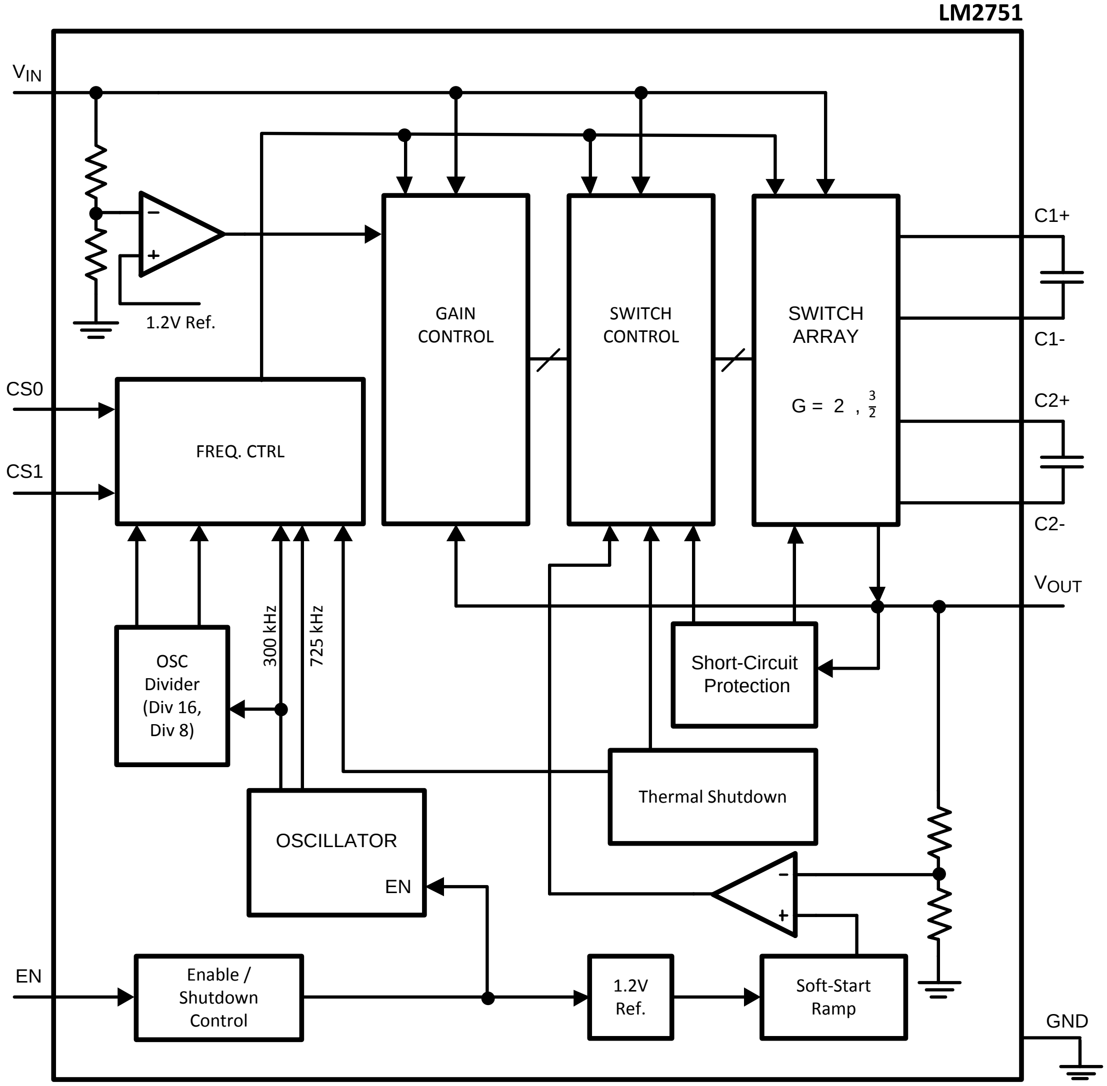
ELECTRICAL CHARACTERISTICS[1][2] (continued)

Limits in standard typeface are for T_A = 25ºC. Limits in **boldface** type apply over the full operating ambient temperature range (-40°C ≤ T_A ≤ +85°C) . Unless otherwise noted, specifications apply to the LM2751 Typical Application Circuit (pg. 1) with: V_{IN} = 3.6V, V(EN) = $V_{IN,}$ CS0 = CS1 = V_{IN}, C_1 = C_2 = 1.0µF, C_{IN} = C_{OUT} = 2.2µF [3].

Symbol	Parameter	Conditions	Min	Typ	Max	Units
t_{ON}	V_{OUT} Turn-On Time[5]			300		µs

(5) Turn-on time is measured from when the EN signal is pulled high until the output voltage on V_{OUT} crosses 90% of its final value.

BLOCK DIAGRAM



TYPICAL PERFORMANCE CHARACTERISTICS

Unless otherwise specified: T_A = 25°C, V_{IN} = 3.6V, CS0 = CS1 = V_{IN}, V(EN) = V_{IN}, C_{IN} = C_{OUT} = 2.2µF, C_1 = C_2 = 1µF.

Output Voltage vs. Output Current, Version A (5V), 300kHz

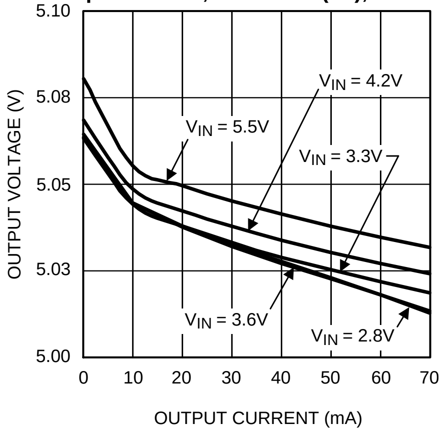


Figure 2.

Output Voltage vs. Output Current, Version B (4.5V), 300kHz

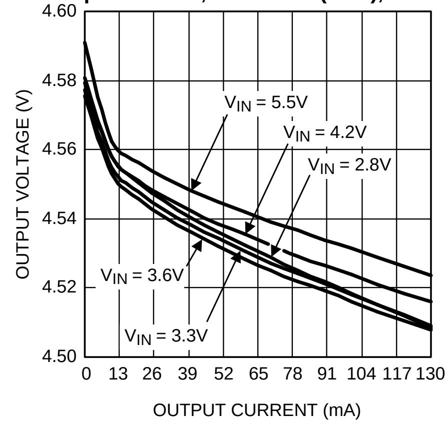


Figure 3.

Output Voltage vs. Output Current, Version A (5V), 725kHz

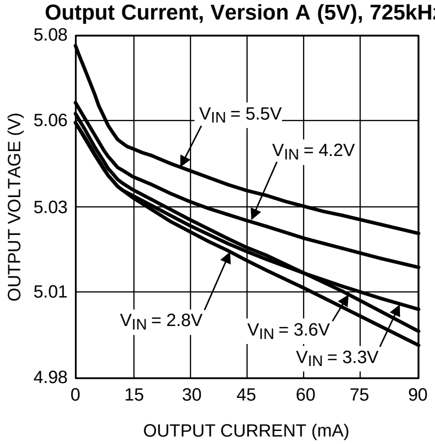


Figure 4.

Output Voltage vs. Output Current, Version B (4.5V), 725kHz

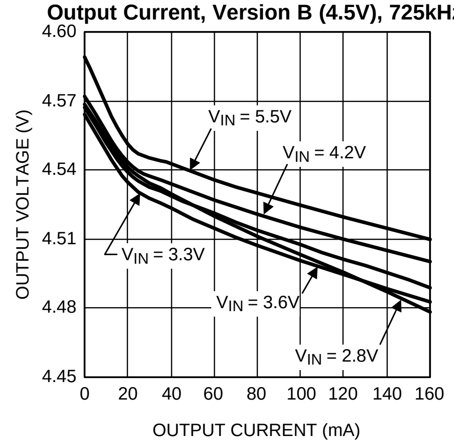


Figure 5.

Input Current vs. Input Voltage, Version A (5V)

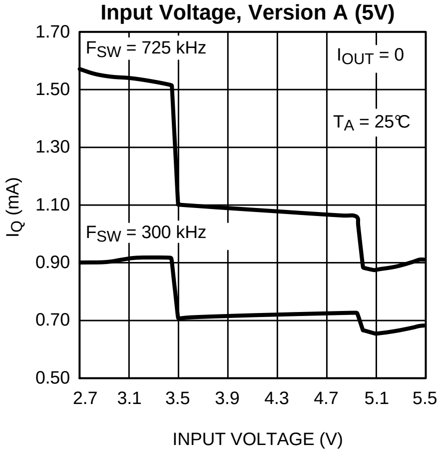


Figure 6.

Input Current vs. Input Voltage, Version B (4.5V)

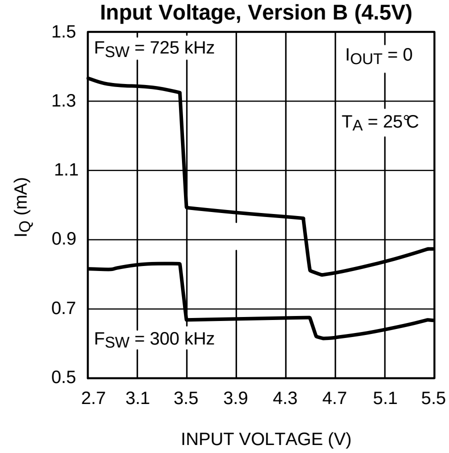


Figure 7.

TYPICAL PERFORMANCE CHARACTERISTICS (continued)

Unless otherwise specified: T_A = 25°C, V_{IN} = 3.6V, CS0 = CS1 = V_{IN}, V(EN) = V_{IN}, C_{IN} = C_{OUT} = 2.2µF, C_1 = C_2 = 1µF.

Output Voltage vs. Input Voltage, Version A (5V), 300kHz

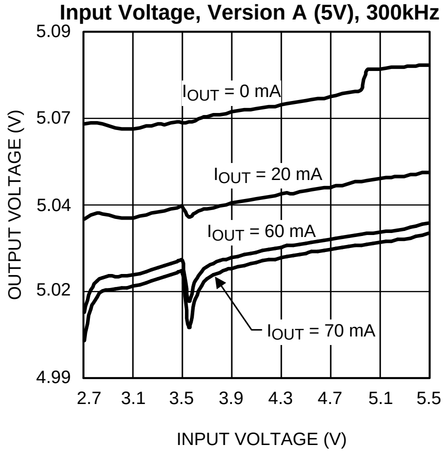


Figure 8.

Output Voltage vs. Input Voltage, Version B (4.5V), 300kHz

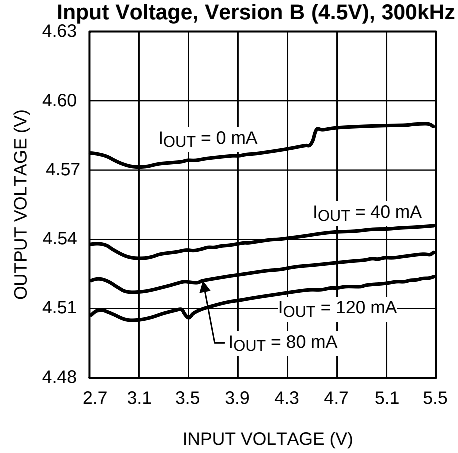


Figure 9.

Output Voltage vs. Input Voltage, Version A (5V), 725kHz

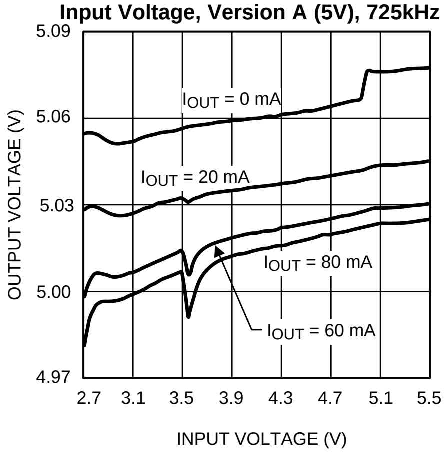


Figure 10.

Output Voltage vs. Input Voltage, Version B (4.5V), 725kHz

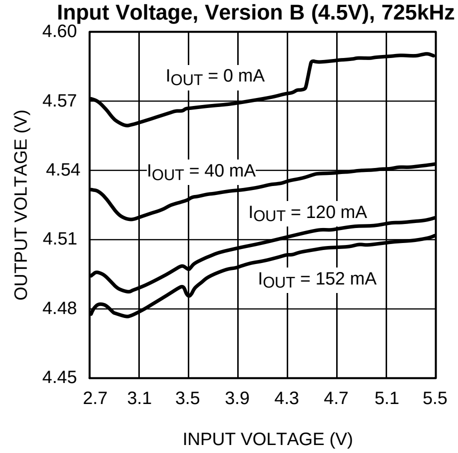


Figure 11.

Efficiency vs. Input Voltage, Version A (5V)

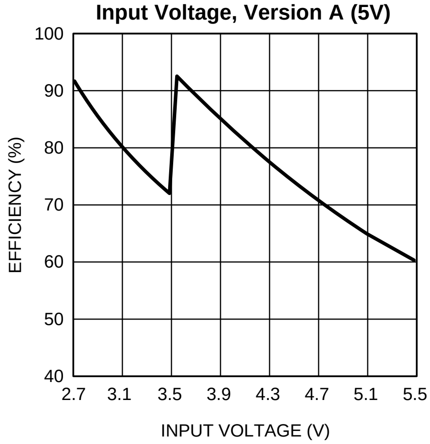


Figure 12.

Efficiency vs. Input Voltage, Version B (4.5V)

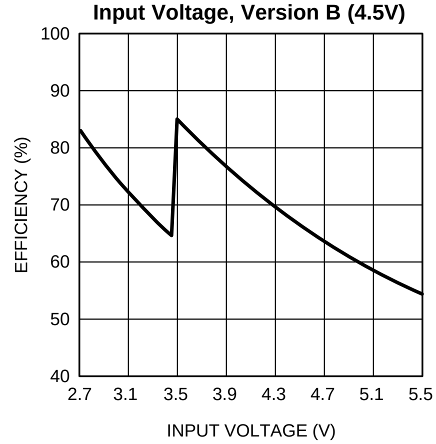


Figure 13.

TYPICAL PERFORMANCE CHARACTERISTICS (continued)

Unless otherwise specified: T_A = 25°C, V_{IN} = 3.6V, CS0 = CS1 = V_{IN}, V(EN) = V_{IN}, C_{IN} = C_{OUT} = 2.2µF, C_1 = C_2 = 1µF.

Output Voltage Ripple vs. Input Voltage Version B (4.5V), Load = 120mA

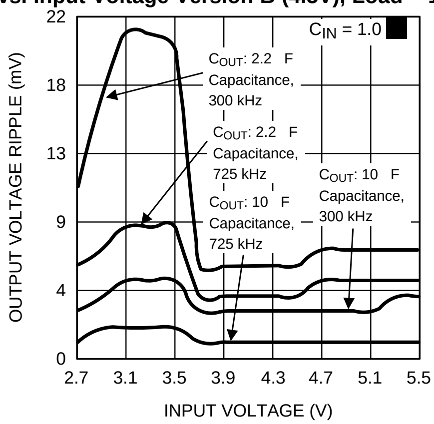
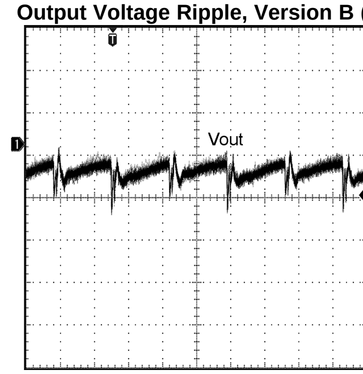


Figure 14.

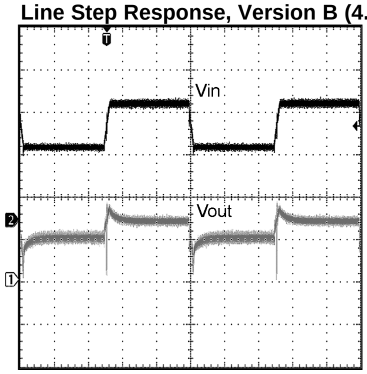
Output Voltage Ripple, Version B (4.5V)



V_{IN} = 3.6V, Load = 150mA
CH1: V_{OUT}; Scale: 10mV/Div, AC Coupled
Time scale: 400ns/Div

Figure 15.

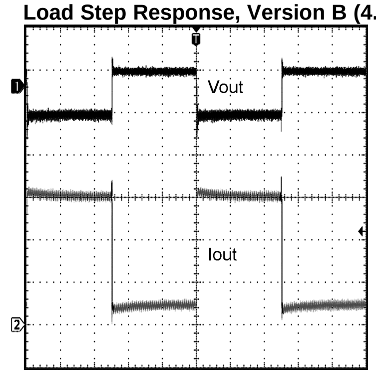
Line Step Response, Version B (4.5V)



V_{IN} = 3.2V - 4.2V Step, Load = 150mA
CH1 (top): V_{IN}; Scale: 1V/Div, DC Coupled
CH2: V_{OUT}; Scale: 50mV/Div, AC Coupled
Time scale: 200µs/Div

Figure 16.

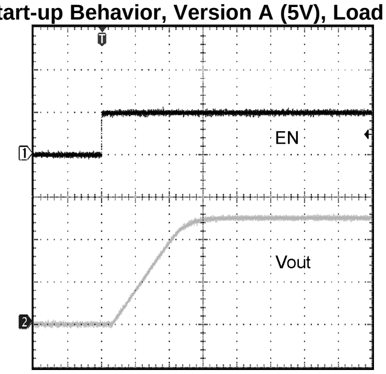
Load Step Response, Version B (4.5V)



V_{IN} = 3.6V, Load = 20mA - 150mA Step
CH1 (top): V_{OUT}; Scale: 50mV/Div, AC Coupled
CH2: Output Current; Scale: 50mA/Div
Time scale: 200µs/Div

Figure 17.

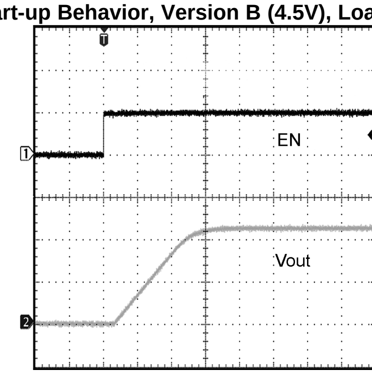
Start-up Behavior, Version A (5V), Load = 80mA



CH1: EN pin; Scale: 2V/Div
CH2: V_{OUT}; Scale: 2V/Div
Time scale: 100µs/Div

Figure 18.

Start-up Behavior, Version B (4.5V), Load = 150mA



CH1: EN pin; Scale: 2V/Div
CH2: V_{OUT}; Scale: 2V/Div
Time scale: 100µs/Div

Figure 19.

APPLICATION INFORMATION

CIRCUIT DESCRIPTION

The LM2751 is a Switched Capacitor Convertor with gains of 2x and 1.5x. It is capable of continuously supplying up to 150mA at 4.5V or up to 80mA at 5V depending on the output voltage option. The LM2751's fixed frequency pre-regulation maintains the output voltage to within 3% (typ.), making it well suited for driving White LEDs. There are also four user programmable switching frequencies to reduce the quiescent current consumption at light loads.

Aside from powering LEDs, the LM2751 is suitable for driving other devices with power requirements up to 150mA. The LM2751 operates over the extended Li-Ion battery range from 2.8V to 5.5V. The LM2751 limits output current to 250mA (typ.) during an output short circuit condition. LED brightness is controlled by applying a PWM (Pulse Width Modulation) signal to the Enable pin (EN). See PWM BRIGHTNESS CONTROL.

SOFT START

Soft Start is engaged when the device is taken out of Shutdown mode (EN = logic HIGH) or when voltage is supplied simultaneously to the V_{IN} and EN pins. During Soft Start, the voltage on V_{OUT} will ramp up in proportion to the rate that the reference voltage is being ramped up. The output voltage is programmed to rise from 0V to the regulated output voltage level (4.5V or 5V) in 300µs (typ.).

ENABLE MODE

The Enable logic pin (EN) disables the part and reduces the quiescent current to 0.77µA (typ.). The LM2751 has an active-high enable pin (LOW = shut down, HIGH = operating) which can be driven with a low-voltage CMOS logic signal (1.5V logic, 1.8V logic, etc). There is an internal 1MΩ pull-down resistor between the EN and GND pins of the LM2751.

FREQUENCY MODE SELECT

The LM2751 switching frequency is user programmable via two logic input pins, CS0 and CS1. Both logic input pins have active-high logic (LOW = un-selected, HIGH = selected) and can be driven with a low-voltage CMOS logic signal (1.5V logic, 1.8V logic, etc). There are no internal pull-down or pull-up resistors between the CSx and GND pins of the LM2751. The CSO and CS1 can be controlled independently or with the same logic signal.

The selectable switching frequencies are 9.5kHz, 37kHz, 300kHz, 725kHz. The switching frequency is programmed according to Table 1.

Table 1. Frequency Modes

CS0	CS1	Frequency
0	0	37kHz
0	1	300kHz
1	0	9.5kHz
1	1	725kHz

V_{OUT} REGULATION

The LM2751 uses pre-regulation to regulate the output voltage to 4.5V or 5.0V depending on the voltage option. Pre-regulation uses the voltage present at V_{OUT} to limit the gate drive of the switched capacitor charge pump. This regulation is done before the voltage is gained up by the charge pump, giving rise to the term "pre-regulation". Pre-regulation helps to reduce input current noise and large input current spikes normally associated with switched capacitor charge pumps.

The LM2751 switched capacitor charge pump has gains of 2x and 1.5x. When the input voltage to the device is greater than 3.58V (typ.), the LM2751 operates in a gain of 1.5x. When the input voltage falls below 3.5V (typ.), the device switches to a gain of 2x.

OUTPUT VOLTAGE RIPPLE

The primary contributor in keeping the output voltage ripple of the LM2751 low is its switching topology. The output capacitance, input voltage, switching frequency and output current also play a significant part in determining the output voltage ripple. Due to the complexity of the LM2751 operation, providing equations or models to approximate the magnitude of the ripple cannot be easily accomplished. However, the following general statements can be made.

The LM2751 has very low output ripple when compared to typical boost regulators due to its double-pump topology, where charge is continually supplied to the output during both 2x and 1.5x modes. Combined with fixed frequency operation modes, double-pumping allows for the use of a very small, low value ceramic capacitor on the output node while still achieving minimal output ripple. Increasing the capacitance by adding a higher value capacitor or placing multiple capacitors in parallel can further reduce the ripple magnitude.

CAPACITOR SELECTION

The LM2751 requires 4 external capacitors for proper operation. Surface-mount multi-layer ceramic capacitors are recommended. These capacitors are small, inexpensive and have very low equivalent series resistance (ESR, ≤15mΩ typ.). Tantalum capacitors, OS-CON capacitors, and aluminum electrolytic capacitors are generally not recommended for use with the LM2751 due to their high ESR, as compared to ceramic capacitors.

For most applications, ceramic capacitors with X7R or X5R temperature characteristic are preferred for use with the LM2751. These capacitors have tight capacitance tolerance (as good as ±10%), hold their value over temperature (X7R: ±15% over −55°C to 125°C; X5R: ±15% over −55°C to 85°C), and typically have little voltage coefficient when compared to other types of capacitors. However selecting a capacitor with a voltage rating much higher than the voltage it will be subjected to, will ensure that the capacitance will stay closer to the capacitor's nominal value. Capacitors with Y5V or Z5U temperature characteristic are generally not recommended for use with the LM2751. Capacitors with these temperature characteristics typically have wide capacitance tolerance (+80%, −20%), vary significantly over temperature (Y5V: +22%, −82% over −30°C to +85°C range; Z5U: +22%, −56% over +10°C to +85°C range), and have poor voltage coefficients. Under some conditions, a nominal 1µF Y5V or Z5U capacitor could have a capacitance of only 0.1µF. Such detrimental deviation is likely to cause Y5V and Z5U capacitors to fail to meet the minimum capacitance requirements of the LM2751.

The voltage rating of the output capacitor should be 10V or more. All other capacitors should have a voltage rating at or above the maximum input voltage of the application.

DRIVING WHITE LEDS

The desired LED current is set by placing a resistor (R) in series with each LED, and is determined by the equation:

$$I_{LED} = (V_{OUT} - V_{LED}) \div R \quad (1)$$

In the equation above, I_{LED} is the current that flows through a particular LED, and V_{LED} is the forward voltage of the LED at the given current. The output voltage (V_{OUT}) of the LM2751 is tightly regulated to 4.5V or 5V depending on the output voltage option. However, LED forward voltage varies from LED to LED, and LED current will vary accordingly. Mismatch of LED currents will result in brightness mismatch from one LED to the next. Therefore it is suggested that LED groups with tightly controlled I-V characteristics ("Binned" LEDs) be used. LEDs with looser tolerance can be used in applications where brightness matching is not critical, such as in keypad or general backlighting. The typical and maximum diode forward voltage depends highly on the manufacturer and their technology.

PWM BRIGHTNESS CONTROL

Perceived LED brightness can be adjusted using a PWM control signal on the Enable pin of the LM2751, to turn the voltage output ON and OFF at a rate faster than perceptible by the eye. When this is done, the total brightness perceived is proportional to the duty cycle (D) of the PWM signal (D = the percentage of time that the LED is on in every PWM cycle). A simple example: if the LEDs are driven at 15mA each with a PWM signal that has a 50% duty cycle, perceived LED brightness will be about half as bright as compared to when the LEDs are driven continuously with 15mA.

For linear brightness control over the full duty cycle adjustment range, the PWM frequency (f) should be limited to accommodate the turn-on time (typ. T_{ON} = 300µs) of the device.

$$D \times (1/f) > T_{ON} \quad (2)$$

$$f_{MAX} = D_{MIN} \div T_{ON} \quad (3)$$

The minimum recommended PWM frequency is 100Hz. Frequencies below this may be visibly noticeable as flicker or blinking. The maximum recommended PWM frequency is 1kHz. Frequencies above this may cause noise in the audible range.

THERMAL PROTECTION

When the junction temperature exceeds 150°C (typ.), internal thermal protection circuitry disables the device. This feature protects the LM2751 from damage due to excessive power dissipation. The device will recover and operate normally when the junction temperature falls below 140°C (typ.). It is important to have good thermal conduction with a proper layout to reduce thermal resistance.

POWER EFFICIENCY

Charge-Pump efficiency is derived in the following two ideal equations (supply current and other losses are neglected for simplicity):

$$I_{IN} = G \times I_{OUT} \quad (4)$$

$$E = (V_{OUT} \times I_{OUT}) \div (V_{IN} \times I_{IN}) = V_{OUT} \div (G \times V_{IN}) \quad (5)$$

In the equations, G represents the charge pump gain. Efficiency is at its highest as G x V_{IN} approaches V_{OUT}. Refer to the efficiency graph in the Typical Performance Characteristics for the detailed efficiency data.

POWER DISSIPATION

The power dissipation ($P_{DISSIPATION}$) and junction temperature (T_J) can be approximated with the equations below. P_{IN} is the product of the input current and input voltage, P_{OUT} is the power consumed by the load connected to the output, $T_A$is the ambient temperature, and θ_{JA} is the junction-to-ambient thermal resistance for the 10-pin SON package. V_{IN} is the input voltage to the LM2751, V_{VOUT} is the voltage at the output of the device, and I_{OUT} is the total current supplied to the load connected to V_{OUT}.

$$P_{DISSIPATION} = P_{IN} - P_{OUT} \quad (6)$$

$$= (V_{IN} \times I_{IN}) - (V_{VOUT} \times I_{OUT}) \quad (7)$$

$$T_J = T_A + (P_{DISSIPATION} \times \theta_{JA}) \quad (8)$$

The junction temperature rating takes precedence over the ambient temperature rating. The LM2751 may be operated outside the ambient temperature rating, so long as the junction temperature of the device does not exceed the maximum operating rating of 115°C. The maximum ambient temperature rating must be derated in applications where high power dissipation and/or poor thermal resistance causes the junction temperature to exceed 115°C.

REVISION HISTORY

Changes from Revision A (May 2013) to Revision B	Page
• Changed layout of National Data Sheet to TI format	12

PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package | Pins	Package qty | Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
LM2751SD-B/NOPB	Active	Production	WSON (DSC) | 10	1000 | SMALL T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 85	L146B
LM2751SD-B/NOPB.A	Active	Production	WSON (DSC) | 10	1000 | SMALL T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 85	L146B

(1) **Status:** For more details on status, see our product life cycle.

(2) **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

(3) **RoHS values:** Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

(4) **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

(5) **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

(6) **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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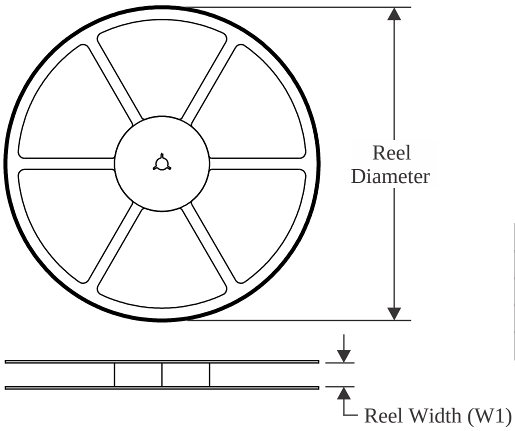
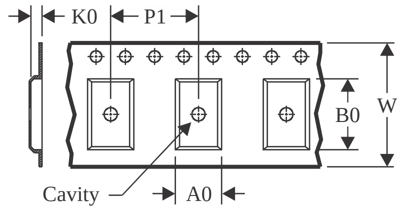
In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

TAPE AND REEL INFORMATION

REEL DIMENSIONS

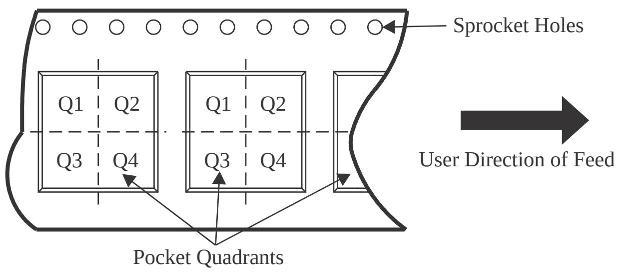


TAPE DIMENSIONS



A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

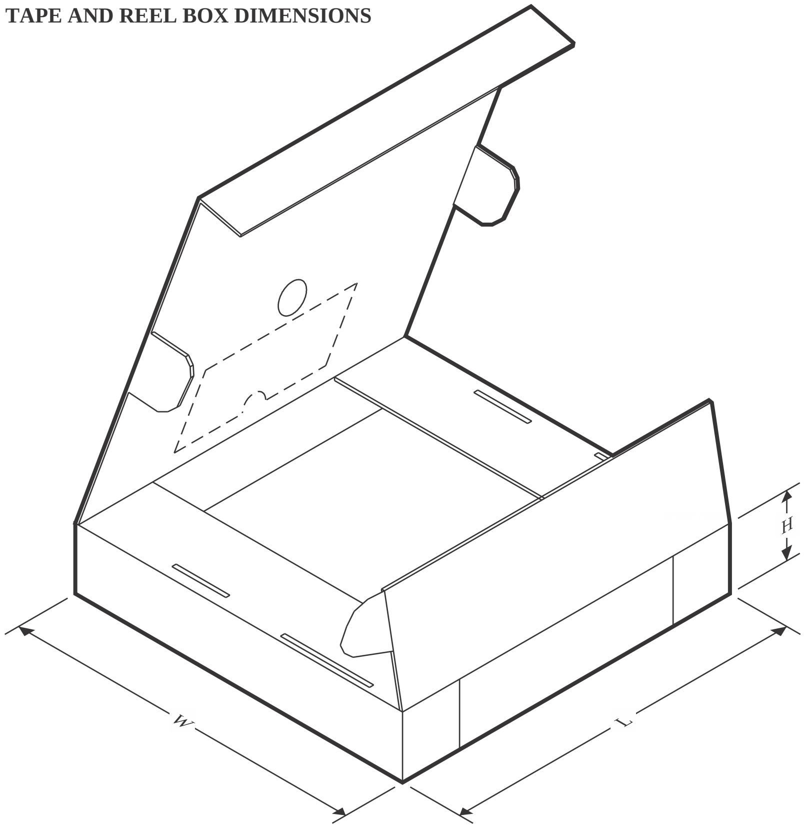
QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
LM2751SD-B/NOPB	WSON	DSC	10	1000	177.8	12.4	3.3	3.3	1.0	8.0	12.0	Q1

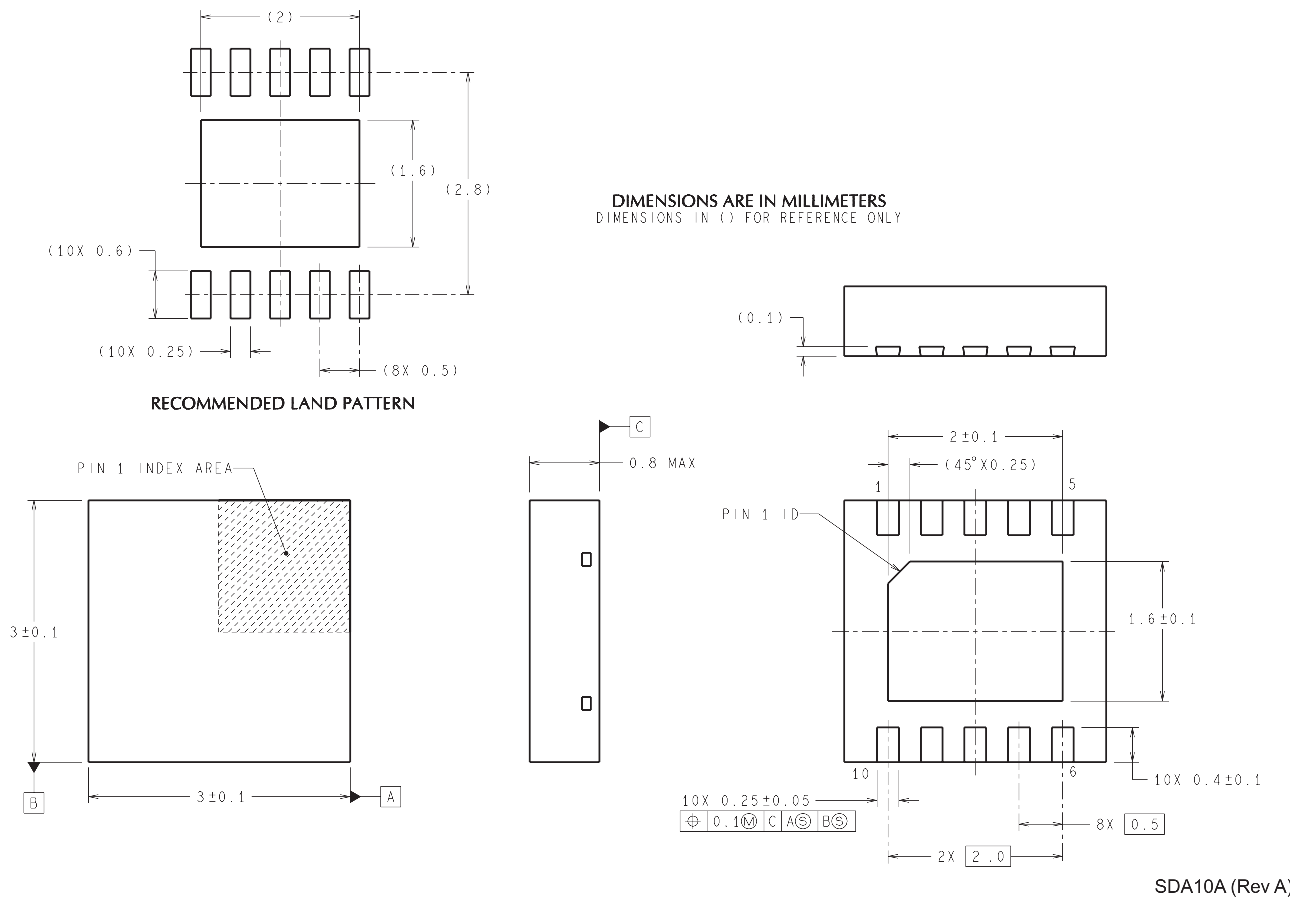
TAPE AND REEL BOX DIMENSIONS



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
LM2751SD-B/NOPB	WSON	DSC	10	1000	210.0	185.0	35.0

DSC0010A



(2)
(1.6)
(2.8)
(10X 0.6)
(10X 0.25)
(8X 0.5)
RECOMMENDED LAND PATTERN
DIMENSIONS ARE IN MILLIMETERS
DIMENSIONS IN ( ) FOR REFERENCE ONLY
(0.1)
PIN 1 INDEX AREA
3±0.1
3±0.1
A
B
C
0.8 MAX
2±0.1
(45°X0.25)
1
5
PIN 1 ID
1.6±0.1
10
6
10X 0.4±0.1
10X 0.25±0.05
0.1 M C A S B S
8X 0.5
2X 2.0
SDA10A (Rev A)